勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

## Features

- Low-voltage and Standard-voltage Operation
  - $-2.7 (V_{CC} = 2.7V \text{ to } 5.5V)$
  - 1.8 (V<sub>CC</sub> = 1.8V to 5.5V)
- Internally Organized 128 x 8 (1K), 256 x 8 (2K), 512 x 8 (4K), 1024 x 8 (8K) or 2048 x 8 (16K)
- Two-wire Serial Interface
- Schmitt Trigger, Filtered Inputs for Noise Suppression
- Bidirectional Data Transfer Protocol
- 100 kHz (1.8V) and 400 kHz (2.7V, 5V) Compatibility
- Write Protect Pin for Hardware Data Protection
- 8-byte Page (1K, 2K), 16-byte Page (4K, 8K, 16K) Write Modes
- Partial Page Writes Allowed
- Self-timed Write Cycle (5 ms max)
- High-reliability
  - Endurance: 1 Million Write Cycles
  - Data Retention: 100 Years
- Automotive Devices Available
- 8-lead JEDEC PDIP, 8-lead JEDEC SOIC, 8-lead Ultra Thin Mini-MAP (MLP 2x3), 5-lead SOT23, 8-lead TSSOP and 8-ball dBGA2 Packages
- Die Sales: Wafer Form, Waffle Pack and Bumped Wafers

## Description

The AT24C01A/02/04/08A/16A provides 1024/2048/4096/8192/16384 bits of serial electrically erasable and programmable read-only memory (EEPROM) organized as 128/256/512/1024/2048 words of 8 bits each. The device is optimized for use in many industrial and commercial applications where low-power and low-voltage operation are essential. The AT24C01A/02/04/08A/16A is available in space-saving 8-lead PDIP, 8-lead JEDEC SOIC, 8-lead Ultra Thin Mini-MAP (MLP 2x3), 5-lead SOT23 (AT24C01A/AT24C02/AT24C04), 8-lead TSSOP, and 8-ball dBGA2 packages and is accessed via a Two-wire serial interface. In addition, the entire family is available in 2.7V (2.7V to 5.5V) and 1.8V (1.8V to 5.5V) versions.

A0 🗆 1

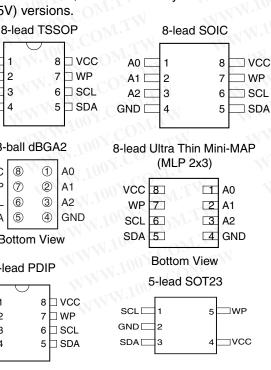
A1 🗆 2

A2 🗆 3

4

GND 🗆

Table 1. Pir	Table 1. Pin Configuration		-lead		SC T
Pin Name	Function	A0 🗆	1		8
A0 - A2	Address Inputs		2 3		7 6
SDA	Serial Data	GND 🗆	4	W	5
SCL	Serial Clock Input			N	Ń
WP	Write Protect	8-	ball c	IBG/	42 7
NC	No Connect	VCC	8	1	A
GND	Ground	WP SCL	76	2 3	A
VCC	Power Supply	SDA	5	4	Ģ
		B	ottom	n Vie	w
		8-le	ead F	DIP	
			$\bigcirc$		





Two-wire Serial EEPROM

1K (128 x 8)

2K (256 x 8)

4K (512 x 8)

8K (1024 x 8)

16K (2048 x 8)

AT24C01A AT24C02<sup>(1)</sup> AT24C04 AT24C08A AT24C16A

Note: 1. Not Recommended for new design; Please refer to 24C02B datasheet.

0180Y-SEEPR-2/06





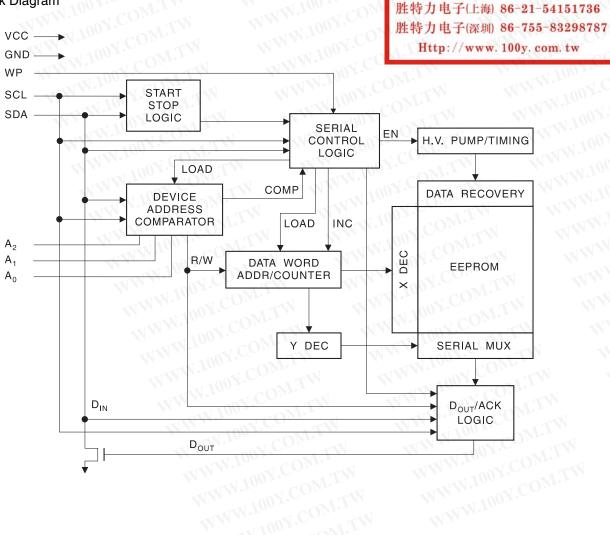
## **Absolute Maximum Ratings**

Operating Temperature	–55°C to +125°C
Storage Temperature	–65°C to +150°C
Voltage on Any Pin with Respect to Ground	1.0V to +7.0V
Maximum Operating Voltage	6.25V
DC Output Current	5.0 mA

### Figure 1. Block Diagram

\*NOTICE: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

勝特力材料 886-3-5753170



## **Pin Description**

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**SERIAL DATA (SDA):** The SDA pin is bidirectional for serial data transfer. This pin is open-drain driven and may be wire-ORed with any number of other open-drain or open-collector devices.

**DEVICE/PAGE ADDRESSES (A2, A1, A0):** The A2, A1 and A0 pins are device address inputs that are hard wired for the AT24C01A and the AT24C02. As many as eight 1K/2K devices may be addressed on a single bus system (device addressing is discussed in detail under the Device Addressing section).

The AT24C04 uses the A2 and A1 inputs for hard wire addressing and a total of four 4K devices may be addressed on a single bus system. The A0 pin is a no connect and can be connected to ground.

The AT24C08A only uses the A2 input for hardwire addressing and a total of two 8K devices may be addressed on a single bus system. The A0 and A1 pins are no connects and can be connected to ground.

The AT24C16A does not use the device address pins, which limits the number of devices on a single bus to one. The A0, A1 and A2 pins are no connects and can be connected to ground.

**WRITE PROTECT (WP):** The AT24C01A/02/04/08A/16A has a Write Protect pin that provides hardware data protection. The Write Protect pin allows normal Read/Write operations when connected to ground (GND). When the Write Protect pin is connected to  $V_{CC}$ , the write protection feature is enabled and operates as shown in Table 2.

### Table 2. Write Protect

WP Pin	Part of the Array Protected					
Status	24C01A	24C02	24C04	24C08A	24C16A	
At V <sub>CC</sub>	Full (1K) Array	Full (2K) Array	Full (4K) Array	Full (8K) Array	Full (16K) Array	
At GND	Normal Read/V	Vrite Operations	1003	CON.TV	W.	

# **Memory Organization** AT24C01A, 1K SERIAL EEPROM: Internally organized with 16 pages of 8 bytes each, the 1K requires a 7-bit data word address for random word addressing.

**AT24C02, 2K SERIAL EEPROM:** Internally organized with 32 pages of 8 bytes each, the 2K requires an 8-bit data word address for random word addressing.

**AT24C04, 4K SERIAL EEPROM:** Internally organized with 32 pages of 16 bytes each, the 4K requires a 9-bit data word address for random word addressing.

**AT24C08A, 8K SERIAL EEPROM:** Internally organized with 64 pages of 16 bytes each, the 8K requires a 10-bit data word address for random word addressing.

**AT24C16A, 16K SERIAL EEPROM:** Internally organized with 128 pages of 16 bytes each, the 16K requires an 11-bit data word address for random word addressing.





## Table 3. Pin Capacitance<sup>(1)</sup>

Applicable over recommended operating range from  $T_A = 25^{\circ}C$ , f = 1.0 MHz,  $V_{CC} = +1.8V$ 

Symbol	Test Condition	Max	Units	Conditions
C <sub>I/O</sub>	Input/Output Capacitance (SDA)	8	pF	$V_{I/O} = 0V$
C <sub>IN</sub>	Input Capacitance (A <sub>0</sub> , A <sub>1</sub> , A <sub>2</sub> , SCL)	6	pF	$V_{IN} = 0V$

### Table 4. DC Characteristics

MINOY.COMIN W100X.COM.TW Applicable over recommended operating range from:  $T_{AI} = -40^{\circ}C$  to  $+85^{\circ}C$ ,  $V_{CC} = +1.8V$  to +5.5V,  $V_{CC} = +1.8V$  to +5.5VNWW.10 (unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Тур	Max	Units
V <sub>CC1</sub>	Supply Voltage	WW.100	1.8		5.5	V
V <sub>CC2</sub>	Supply Voltage	1.WW.10	2.7		5.5	V
V <sub>CC3</sub>	Supply Voltage	T.I.W. W.W.	4.5	1	5.5	V
сс	Supply Current $V_{CC} = 5.0V$	READ at 100 kHz	1001.001	0.4	1.0	mA
I <sub>cc</sub>	Supply Current V <sub>CC</sub> = 5.0V	WRITE at 100 kHz	V.100X.CC	2.0	3.0	mA
I <sub>SB1</sub>	Standby Current $V_{CC} = 1.8V$	$V_{IN} = V_{CC} \text{ or } V_{SS}$	W.100X.C	0.6	3.0	μA
I <sub>SB2</sub>	Standby Current $V_{CC} = 2.5V$	$V_{IN} = V_{CC} \text{ or } V_{SS}$	W.100Y.C	1.4	4.0	μA
I <sub>SB3</sub>	Standby Current V <sub>CC</sub> = 2.7V	$V_{IN} = V_{CC} \text{ or } V_{SS}$	N.100Y.	1.6	4.0	μA
I <sub>SB4</sub>	Standby Current V <sub>CC</sub> = 5.0V	$V_{IN} = V_{CC} \text{ or } V_{SS}$	1005	8.0	18.0	μA
ILI	Input Leakage Current	$V_{IN} = V_{CC} \text{ or } V_{SS}$	WW 100	0.10	3.0	μA
LO	Output Leakage Current	$V_{OUT} = V_{CC} \text{ or } V_{SS}$	WW III	0.05	3.0	μA
V <sub>IL</sub>	Input Low Level <sup>(1)</sup>	MIN COMPANY	-0.6	OOX.CO	V <sub>CC</sub> x 0.3	V
V <sub>IH</sub>	Input High Level <sup>(1)</sup>	MTN.COMMENTW	V <sub>CC</sub> x 0.7	100Y.CU	V <sub>CC</sub> + 0.5	V
V <sub>OL2</sub>	Output Low Level V <sub>CC</sub> = 3.0V	I <sub>OL</sub> = 2.1 mA	MMM	TUON.C	0.4	V
V <sub>OL1</sub>	Output Low Level V <sub>CC</sub> = 1.8V	I <sub>OL</sub> = 0.15 mA	WW	.Yooy.	0.2	V <



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# AT24C01A/02/04/08A/16A

### Table 5. AC Characteristics

Applicable over recommended operating range from  $T_{AI} = -40^{\circ}$ C to  $+85^{\circ}$ C,  $V_{CC} = +1.8$ V to +5.5V,  $V_{CC} = +2.7$ V to +5.5V, CL = 1 TTL Gate and 100 pF (unless otherwise noted) WWW.10 COM.

	Parameter	1.8-volt		2.7, 5.0-volt		
Symbol		Min	Max	Min	Max	Units
f <sub>SCL</sub>	Clock Frequency, SCL	T.L.M.	100	WW.10	400	kHz
t <sub>LOW</sub>	Clock Pulse Width Low	4.7		1.2	01	μs
t <sub>HIGH</sub>	Clock Pulse Width High	4.0		0.6	001.	μs
t <sub>l</sub>	Noise Suppression Time <sup>(1)</sup>	M.TV	100	W	50	ns
t <sub>AA</sub>	Clock Low to Data Out Valid	0.1	4.5	0.1	0.9	μs
t <sub>BUF</sub>	Time the bus must be free before a new transmission can start <sup>(1)</sup>	4.7	TW TW	1.2	W.100%	μs
t <sub>HD.STA</sub>	Start Hold Time	4.0	WT	0.6	NW.10	μs
t <sub>SU.STA</sub>	Start Setup Time	4.7	Wa	0.6	WW.L	μs
t <sub>HD.DAT</sub>	Data In Hold Time	0	M.I	0	WWW.	μs
t <sub>SU.DAT</sub>	Data In Setup Time	200	OM.I	100	WWW	ns
t <sub>R</sub>	Inputs Rise Time <sup>(1)</sup>	1.100 1.	01.0	N.	0.3	μs
t <sub>F</sub>	Inputs Fall Time <sup>(1)</sup>	W.100 1.	300		300	ns
t <sub>SU.STO</sub>	Stop Setup Time	4.7	COM	0.6		μs
t <sub>DH</sub>	Data Out Hold Time	100	CON	50	NY NY	ns
t <sub>wR</sub>	Write Cycle Time	1.W.10	5	M.T.W	5	ms
Endurance <sup>(1)</sup>	5.0V, 25°C, Byte Mode	1M	100X.C	1M		Write Cycles





## **Device Operation**

**CLOCK and DATA TRANSITIONS:** The SDA pin is normally pulled high with an external device. Data on the SDA pin may change only during SCL low time periods (see Figure 4 on page 7). Data changes during SCL high periods will indicate a start or stop condition as defined below.

**START CONDITION:** A high-to-low transition of SDA with SCL high is a start condition which must precede any other command (see Figure 5 on page 8).

**STOP CONDITION:** A low-to-high transition of SDA with SCL high is a stop condition. After a read sequence, the stop command will place the EEPROM in a standby power mode (see Figure 5 on page 8).

**ACKNOWLEDGE:** All addresses and data words are serially transmitted to and from the EEPROM in 8-bit words. The EEPROM sends a zero to acknowledge that it has received each word. This happens during the ninth clock cycle.

**STANDBY MODE:** The AT24C01A/02/04/08A/16A features a low-power standby mode which is enabled: (a) upon power-up and (b) after the receipt of the STOP bit and the completion of any internal operations.

**MEMORY RESET:** After an interruption in protocol, power loss or system reset, any 2wire part can be reset by following these steps:

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1. Clock up to 9 cycles.

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- 2. Look for SDA high in each cycle while SCL is high.
- 3. Create a start condition.

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## **Bus Timing**

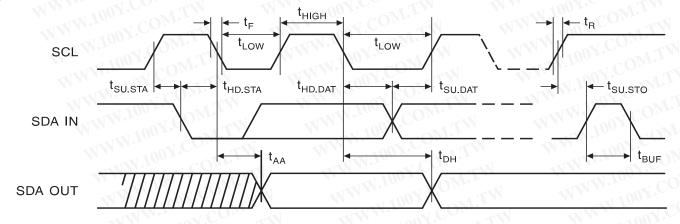
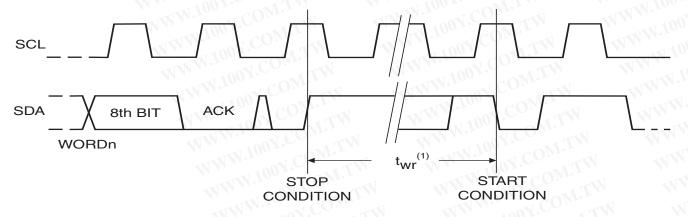


Figure 2. SCL: Serial Clock, SDA: Serial Data I/O®

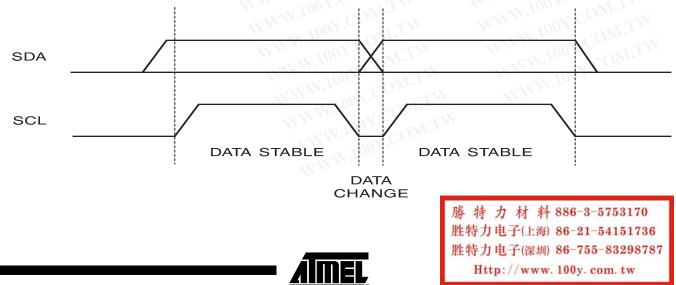
## Write Cycle Timing

Figure 3. SCL: Serial Clock, SDA: Serial Data I/O

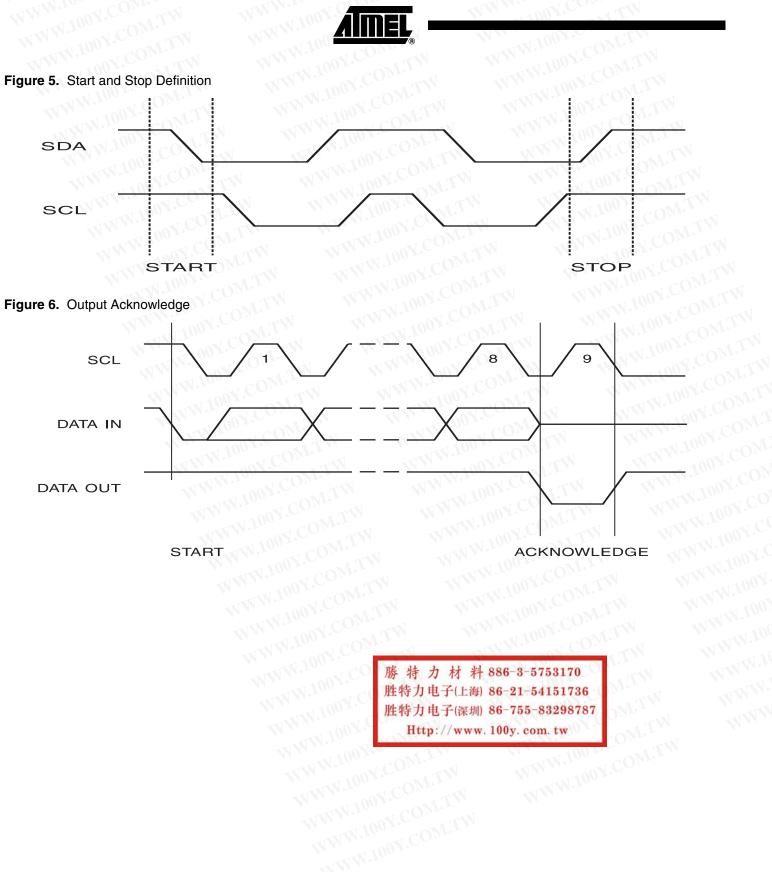


Note: 1. The write cycle time t<sub>WR</sub> is the time from a valid stop condition of a write sequence to the end of the internal clear/write cycle.









## **Device Addressing**

The 1K, 2K, 4K, 8K and 16K EEPROM devices all require an 8-bit device address word following a start condition to enable the chip for a read or write operation (refer to Figure 7).

The device address word consists of a mandatory one, zero sequence for the first four most significant bits as shown. This is common to all the EEPROM devices.

The next 3 bits are the A2, A1 and A0 device address bits for the 1K/2K EEPROM. These 3 bits must compare to their corresponding hard-wired input pins.

The 4K EEPROM only uses the A2 and A1 device address bits with the third bit being a memory page address bit. The two device address bits must compare to their corresponding hard-wired input pins. The A0 pin is no connect.

The 8K EEPROM only uses the A2 device address bit with the next 2 bits being for memory page addressing. The A2 bit must compare to its corresponding hard-wired input pin. The A1 and A0 pins are no connect.

The 16K does not use any device address bits but instead the 3 bits are used for memory page addressing. These page addressing bits on the 4K, 8K and 16K devices should be considered the most significant bits of the data word address which follows. The A0, A1 and A2 pins are no connect.

The eighth bit of the device address is the read/write operation select bit. A read operation is initiated if this bit is high and a write operation is initiated if this bit is low.

Upon a compare of the device address, the EEPROM will output a zero. If a compare is not made, the chip will return to a standby state.

## Write Operations

**BYTE WRITE:** A write operation requires an 8-bit data word address following the device address word and acknowledgment. Upon receipt of this address, the EEPROM will again respond with a zero and then clock in the first 8-bit data word. Following receipt of the 8-bit data word, the EEPROM will output a zero and the addressing device, such as a microcontroller, must terminate the write sequence with a stop condition. At this time the EEPROM enters an internally timed write cycle,  $t_{WR}$ , to the nonvolatile memory. All inputs are disabled during this write cycle and the EEPROM will not respond until the write is complete (see Figure 8 on page 11).

**PAGE WRITE:** The 1K/2K EEPROM is capable of an 8-byte page write, and the 4K, 8K and 16K devices are capable of 16-byte page writes.

A page write is initiated the same as a byte write, but the microcontroller does not send a stop condition after the first data word is clocked in. Instead, after the EEPROM acknowledges receipt of the first data word, the microcontroller can transmit up to seven (1K/2K) or fifteen (4K, 8K, 16K) more data words. The EEPROM will respond with a zero after each data word received. The microcontroller must terminate the page write sequence with a stop condition (see Figure 9 on page 11).

The data word address lower three (1K/2K) or four (4K, 8K, 16K) bits are internally incremented following the receipt of each data word. The higher data word address bits are not incremented, retaining the memory page row location. When the word address, internally generated, reaches the page boundary, the following byte is placed at the beginning of the same page. If more than eight (1K/2K) or sixteen (4K, 8K, 16K) data words are transmitted to the EEPROM, the data word address will "roll over" and previous data will be overwritten.



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**ACKNOWLEDGE POLLING:** Once the internally timed write cycle has started and the EEPROM inputs are disabled, acknowledge polling can be initiated. This involves sending a start condition followed by the device address word. The read/write bit is representative of the operation desired. Only if the internal write cycle has completed will the EEPROM respond with a zero allowing the read or write sequence to continue.

## Read Operations

Read operations are initiated the same way as write operations with the exception that the read/write select bit in the device address word is set to one. There are three read operations: current address read, random address read and sequential read.

**CURRENT ADDRESS READ:** The internal data word address counter maintains the last address accessed during the last read or write operation, incremented by one. This address stays valid between operations as long as the chip power is maintained. The address "roll over" during read is from the last byte of the last memory page to the first byte of the first page. The address "roll over" during write is from the last byte of the current page to the first byte of the same page.

Once the device address with the read/write select bit set to one is clocked in and acknowledged by the EEPROM, the current address data word is serially clocked out. The microcontroller does not respond with an input zero but does generate a following stop condition (see Figure 10 on page 12).

**RANDOM READ:** A random read requires a "dummy" byte write sequence to load in the data word address. Once the device address word and data word address are clocked in and acknowledged by the EEPROM, the microcontroller must generate another start condition. The microcontroller now initiates a current address read by sending a device address with the read/write select bit high. The EEPROM acknowledges the device address and serially clocks out the data word. The microcontroller does not respond with a zero but does generate a following stop condition (see Figure 11 on page 12).

**SEQUENTIAL READ:** Sequential reads are initiated by either a current address read or a random address read. After the microcontroller receives a data word, it responds with an acknowledge. As long as the EEPROM receives an acknowledge, it will continue to increment the data word address and serially clock out sequential data words. When the memory address limit is reached, the data word address will "roll over" and the sequential read will continue. The sequential read operation is terminated when the microcontroller does not respond with a zero but does generate a following stop condition (see Figure 12 on page 12).

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# WWW.100Y.COM.TW Figure 7. Device Address

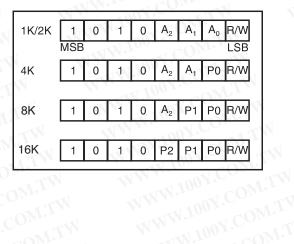
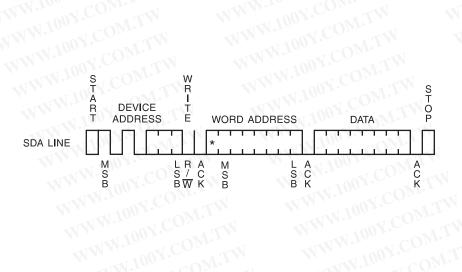
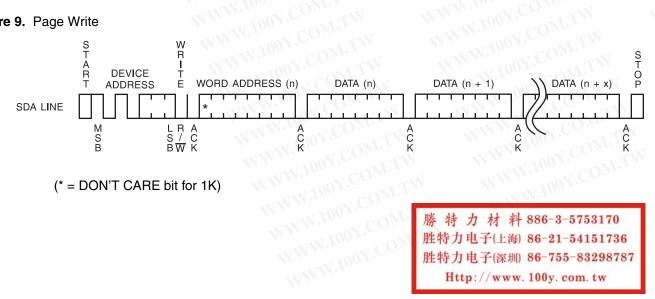


Figure 8. Byte Write



### Figure 9. Page Write







### Figure 10. Current Address Read

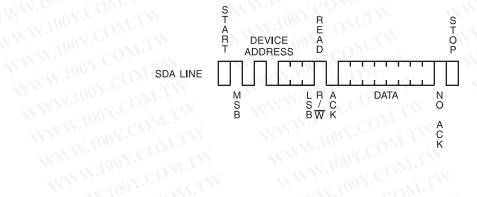
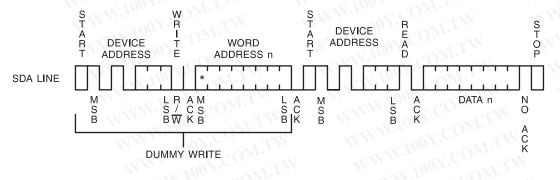
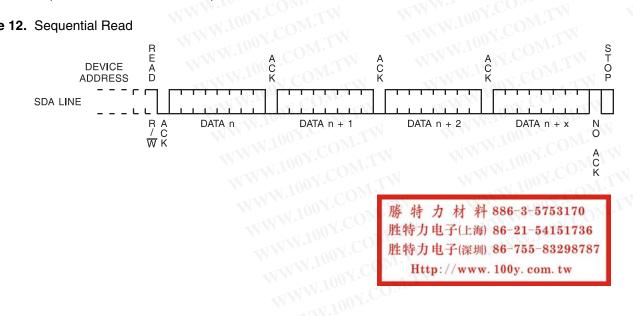


Figure 11. Random Read



(\* = DON'T CARE bit for 1K)

### Figure 12. Sequential Read



Ordering Code	Package	Operation Range
AT24C01A-10PU-2.7 <sup>(2)</sup>	8P3	WIN 100X.CO.TW
AT24C01A-10PU-1.8 <sup>(2)</sup>	8P3	WWW.LOON.COM.
AT24C01A-10SU-2.7 <sup>(2)</sup>	8S1	WW.100 COM.1
AT24C01A-10SU-1.8 <sup>(2)</sup>	8S1	WWW 1002. WIT
AT24C01A-10TU-2.7 <sup>(2)</sup>	8A2	Lead-free/Halogen-free/ Industrial Temperature
AT24C01A-10TU-1.8 <sup>(2)</sup>	8A2	(–40°C to 85°C)
AT24C01A-10TSU-1.8 <sup>(2)</sup>	5TS1	(-40 C 10 85 C)
AT24C01AU3-10UU-1.8 <sup>(2)</sup>	8U31	WWWWWWWWWW
AT24C01AY1-10YU-1.8 <sup>(2)</sup> (Not recommended for new design)	8Y1	WWW. LOP
AT24C01AY6-10YH-1.8 <sup>(3)</sup>	8Y6	LU TWW.10° CO
AT24C01A-W1.8-11 <sup>(4)</sup>	Die Sale	Industrial Temperature (-40°C to 85°C)

# AT24C01A Ordering Information<sup>(1)</sup>

Notes: 1. For 2.7V devices used in the 4.5V to 5.5V range, please refer to performance values in the AC and DC characteristics table.

2. "U" designates Green Package + RoHS compliant.

3. "H" designates Green Package + RoHS compliant, with NiPdAu Lead Finish.

4. Available in waffle pack and wafer form; order as SL788 for inkless wafer form. Bumped die available upon request. Please contact Serial EEPROM Marketing.

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	WWW.100Y.COM.TW WWW.100Y.COM.TW
	Package Type
8P3	8-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)
8S1	8-lead, 0.150" Wide, Plastic Gull Wing Small Outline (JEDEC SOIC)
8A2	8-lead, 4.4 mm Body, Plastic Thin Shrink Small Outline Package (TSSOP)
8Y1	8-lead, 4.90 mm x 3.00 mm Body, Dual Footprint, Non-leaded, Miniature Array Package (MAP)
8Y6	8-lead, 2.00 x 3.00 mm Body, 0.50 mm Pitch, Ultra Thin Mini-MAP, Dual No Lead Package (DFN), (MLP 2x3 mm)
5TS1	5-lead, 2.90 mm x 1.60 mm Body, Plastic Thin Shrink Small Outline Package (SOT23)
8U3-1	8-ball, die Ball Grid Away Package (dBGA2)
	Options
-2.7	Low-voltage (2.7V to 5.5V)
-1.8	Low-voltage (1.8V to 5.5V)





# AT24C02 Ordering Information<sup>(1)</sup>

Ordering Code	Package	Operation Range
AT24C02-10PU-2.7 <sup>(2)</sup>	8P3	W.Ive COM.
AT24C02-10PU-1.8 <sup>(2)</sup>	8P3	WW 100Y.COM.TW
AT24C02N-10SU-2.7 <sup>(2)</sup>	8S1	WWW.Loov.COM
AT24C02N-10SU-1.8 <sup>(2)</sup>	8S1	Lead-free/Halogen-free/
AT24C02-10TU-2.7 <sup>(2)</sup>	8A2	Industrial Temperature
AT24C02-10TU-1.8 <sup>(2)</sup>	8A2	(–40°C to 85°C)
AT24C02Y1-10YU-1.8 <sup>(2)</sup>	8Y1	COM.
AT24C02-10TSU-1.8 <sup>(2)</sup>	5TS1	TW WWW 1002.0 M
AT24C02U3-10UU-1.8 <sup>(2)</sup>	8U3-1	WWW.LCOM
AT24C02-W2.7-11 <sup>(3)</sup>	Die Sale	Industrial Temperature (-40°C to 85°C)

Notes: 1. This device is not recommended for new design. Please refer to AT24C02B datasheet. For 2.7V devices used in the 4.5V to 5.5V range, please refer to performance values in the AC and DC characteristics table.

- 2. "U" designates Green Package + RoHS compliant.
- 3. Available in waffle pack and wafer form; order as SL719 for wafer form. Bumped die available upon request. Please contact Serial EEPROM Marketing.

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	Package Type
8P3	8-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)
8S1	8-lead, 0.150" Wide, Plastic Gull Wing Small Outline (JEDEC SOIC)
8A2	8-lead, 4.4 mm Body, Plastic Thin Shrink Small Outline Package (TSSOP)
8Y1	8-lead, 4.90 mm x 3.00 mm Body, Dual Footprint, Non-leaded, Miniature Array Package (MAP)
5TS1	5-lead, 2.90 mm x 1.60 mm Body, Plastic Thin Shrink Small Outline Package (SOT23)
8U3-1	8-ball, die Ball Grid Away Package (dBGA2)
	Options
-2.7	Low-voltage (2.7V to 5.5V)
-1.8	Low-voltage (1.8V to 5.5V)

Ordering Code	Package	Operation Range
AT24C04-10PU-2.7 <sup>(2)</sup>	8P3	WWW. COMMIN
AT24C04-10PU-1.8 <sup>(2)</sup>	8P3	W.100 COM. 1
AT24C04N-10SU-2.7 <sup>(2)</sup>	8S1	WWW 100Y.CONTY
AT24C04N-10SU-1.8 <sup>(2)</sup>	8S1	LINN VILLAN COMP
AT24C04-10TU-2.7 <sup>(2)</sup>	8A2	Lead-free/Halogen-free/
AT24C04-10TU-1.8 <sup>(2)</sup>	8A2	Industrial Temperature
AT24C04Y1-10YU-1.8 <sup>(2)</sup> (Not recommended for new design)	8Y1	(–40°C to 85°C)
AT24C04Y6-10YH-1.8 <sup>(3)</sup>	8Y6	N 11 100X.C
AT24C04-10TSU-1.8 <sup>(2)</sup>	5TS1	WWW.
AT24C04U3-10UU-1.8 <sup>(2)</sup>	8U3-1	

1. For 2.7V devices used in the 4.5V to 5.5V range, please refer to performance values in the AC and DC characteristics table. Notes:

2. "U" designates Green Package + RoHS compliant.

3. "H" designates Green Package + RoHS compliant, with NiPdAu Lead Finish.

4. Available in waffle pack and wafer form; order as SL788 for inkless wafer form. Bumped die available upon request. Please contact Serial EEPROM Marketing.

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		胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw			
	Package Type	WW.1002 COM.1			
8P3	8-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)	WW.100 Y COM. T			
8S1	8-lead, 0.150" Wide, Plastic Gull Wing Small Outline (JEDEC	C SOIC)			
8A2	8-lead, 4.4 mm Body, Plastic Thin Shrink Small Outline Pack	age (TSSOP)			
8Y1	8-lead, 4.90 mm x 3.00 mm Body, Dual Footprint, Non-leade	d, Miniature Array Package (MAP)			
8Y6	8-lead, 2.00 x 3.00 mm Body, 0.50 mm Pitch, Ultra Thin Mini	-MAP, Dual No Lead Package (DFN), (MLP 2x3 mm)			
5TS1	5-lead, 2.90 mm x 1.60 mm Body, Plastic Thin Shrink Small Outline Package (SOT23)				
8U3-1	8-ball, die Ball Grid Away Package (dBGA2)				
	Options	0			
-2.7	Low-voltage (2.7V to 5.5V)				
-1.8	Low-voltage (1.8V to 5.5V)				





# AT24C08A Ordering Information<sup>(1)</sup>

Ordering Code	Package	Operation Range
AT24C08A-10PU-2.7 <sup>(2)</sup>	8P3	M. Too COM.
AT24C08A-10PU-1.8 <sup>(2)</sup>	8P3	WW 1001.0 M.T
AT24C08AN-10SU-2.7 <sup>(2)</sup>	8S1	WWWWWWWWWWWWWWW
AT24C08AN-10SU-1.8 <sup>(2)</sup>	8S1	Lead-free/Halogen-free/
AT24C08A-10TU-2.7 <sup>(2)</sup>	8A2	Industrial Temperature
AT24C08A-10TU-1.8 <sup>(2)</sup>	8A2	(–40°C to 85°C)
AT24C08AY1-10YU-1.8 <sup>(2)</sup> (Not recommended for new design)	8Y1	WWW. OOY.COM
AT24C08AY6-10YH-1.8 <sup>(3)</sup>	8Y6	N TWW.IO Y CO
AT24C08AU2-10UU-1.8 <sup>(2</sup>	8U2-1	W.1001.
AT24C08A-W1.8-11 <sup>(4)</sup>	Die Sale	Industrial Temperature (–40°C to 85°C)

1. For 2.7V devices used in the 4.5V to 5.5V range, please refer to performance values in the AC and DC characteristics table. Notes:

2. "U" designates Green Package + RoHS compliant.

3. "H" designates Green Package + RoHS compliant, with NiPdAu Lead Finish.

4. Available in waffle pack and wafer form; order as SL788 for inkless wafer form. Bumped die available upon request. Please contact Serial EEPROM Marketing.

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	Package Type
8P3	8-pin, 0.300" Wide, Plastic Dual Inline Package (PDIP)
8S1	8-lead, 0.150" Wide, Plastic Gull Wing Small Outline (JEDEC SOIC)
8A2	8-lead, 4.4 mm Body, Plastic Thin Shrink Small Outline Package (TSSOP)
8Y1	8-lead, 4.90 mm x 3.00 mm Body, Dual Footprint, Non-leaded, Miniature Array Package (MAP)
8Y6	8-lead, 2.00 x 3.00 mm Body, 0.50 mm Pitch, Ultra Thin Mini-MAP, Dual No Lead Package (DFN), (MLP 2x3 mm)
8U2-1	8-ball, die Ball Grid Array Package (dBGA2)
	Options
-2.7	Low Voltage (2.7V to 5.5V)
-1.8	Low Voltage (1.8V to 5.5V)

Ordering Code	Package	Operation Range
AT24C16A-10PU-2.7 <sup>(2)</sup>	8P3	W.IV. COM.
AT24C16A-10PU-1.8 <sup>(2)</sup>	8P3	WW 100X. COM.TW
AT24C16AN-10SU-2.7 <sup>(2)</sup>	8S1	WWW. OOY.CO. TW
AT24C16AN-10SU-1.8 <sup>(2)</sup>	8S1	Lead-free/Halogen-free/
AT24C16A-10TU-2.7 <sup>(2)</sup>	8A2	Industrial Temperature
AT24C16A-10TU-1.8 <sup>(2)</sup>	8A2	(–40°C to 85°C)
AT24C16AY1-10YU-1.8 <sup>(2)</sup> (Not recommended for new design)	8Y1	WWW. OOX.COM
AT24C16AY6-10YH-1.8 <sup>(3)</sup>	8Y6	LINN.100 COM
AT24C16AU2-10UU-1.8 <sup>(2)</sup>	8U2-1	

## AT24C16A Ordering Information<sup>(1)</sup>

Notes: 1. For 2.7V devices used in the 4.5V to 5.5V range, please refer to performance values in the AC and DC characteristics table.

2. "U" designates Green Package + RoHS compliant.

3. "H" designates Green Package + RoHS compliant, with NiPdAu Lead Finish.

4. Available in waffle pack and wafer form; order as SL788 for inkless wafer form. Bumped die available upon request. Please contact Serial EEPROM Marketing.

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> > WWW.100Y.COM.TW

	Package Type
8P3	8-pin, 0.300" Wide, Plastic Dual Inline Package (PDIP)
8S1	8-lead, 0.150" Wide, Plastic Gull Wing Small Outline (JEDEC SOIC)
8A2	8-lead, 0.170" Wide, Thin Shrink Small Outline Package (TSSOP)
8Y1	8-lead, 4.90 mm x 3.00 mm Body, Dual Footprint, Non-leaded, Miniature Array Package (MAP)
8Y6	8-lead, 2.00 x 3.00 mm Body, 0.50 mm Pitch, Ultra Thin Mini-MAP, Dual No Lead Package (DFN), (MLP 2x3 mm)
8U2-1	8-ball, die Ball Grid Array Package (dBGA2)
	Options
-2.7	Low Voltage (2.7V to 5.5V)
-1.8	Low Voltage (1.8V to 5.5V)

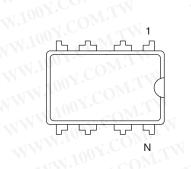




C

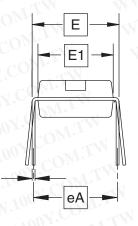
## **Packaging Information**

## 8P3 – PDIP

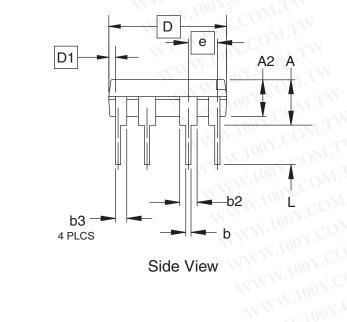


Top View





**End View** 



### **COMMON DIMENSIONS** (Unit of Measure = inches)

SYMBOL	MIN	NOM	МАХ	NOTE
A		17	0.210	2
A2	0.115	0.130	0.195	WW
b	0.014	0.018	0.022	5
b2	0.045	0.060	0.070	6
b3	0.030	0.039	0.045	6
с	0.008	0.010	0.014	
D	0.355	0.365	0.400	3
D1	0.005	$_{1}C^{ON}$		3
Е	0.300	0.310	0.325	4
E1	0.240	0.250	0.280	3
e 🔨		0.100 BSC		
eA	MN.	0.300 BSC		4
L	0.115	0.130	0.150	2

Notes:

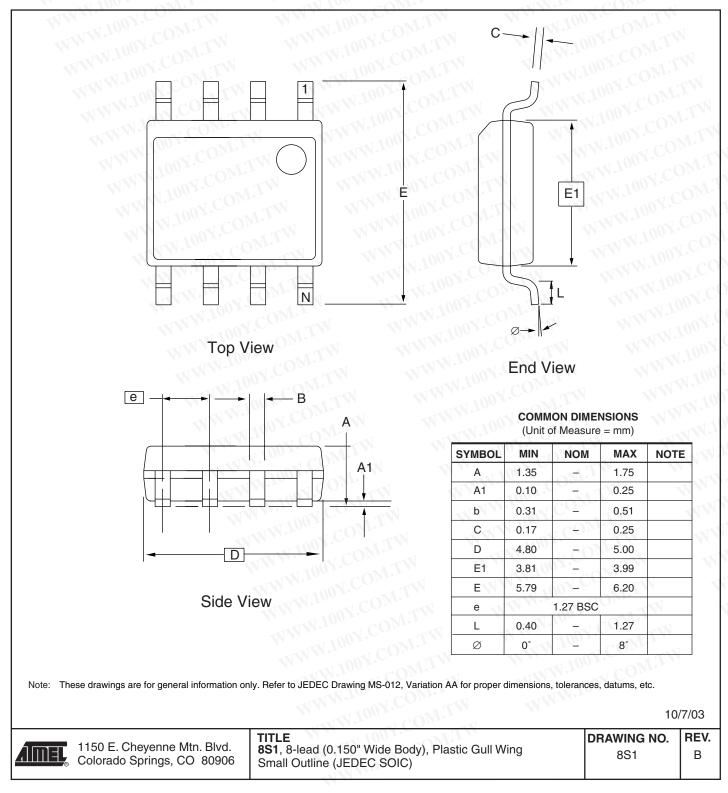
This drawing is for general information only; refer to JEDEC Drawing MS-001, Variation BA, for additional information.
 Dimensions A and L are measured with the package seated in JEDEC seating plane Gauge GS-3.
 D, D1 and E1 dimensions do not include mold Flash or protrusions. Mold Flash or protrusions shall not exceed 0.010 inch.

- 4. E and eA measured with the leads constrained to be perpendicular to datum.
- 5. Pointed or rounded lead tips are preferred to ease insertion.

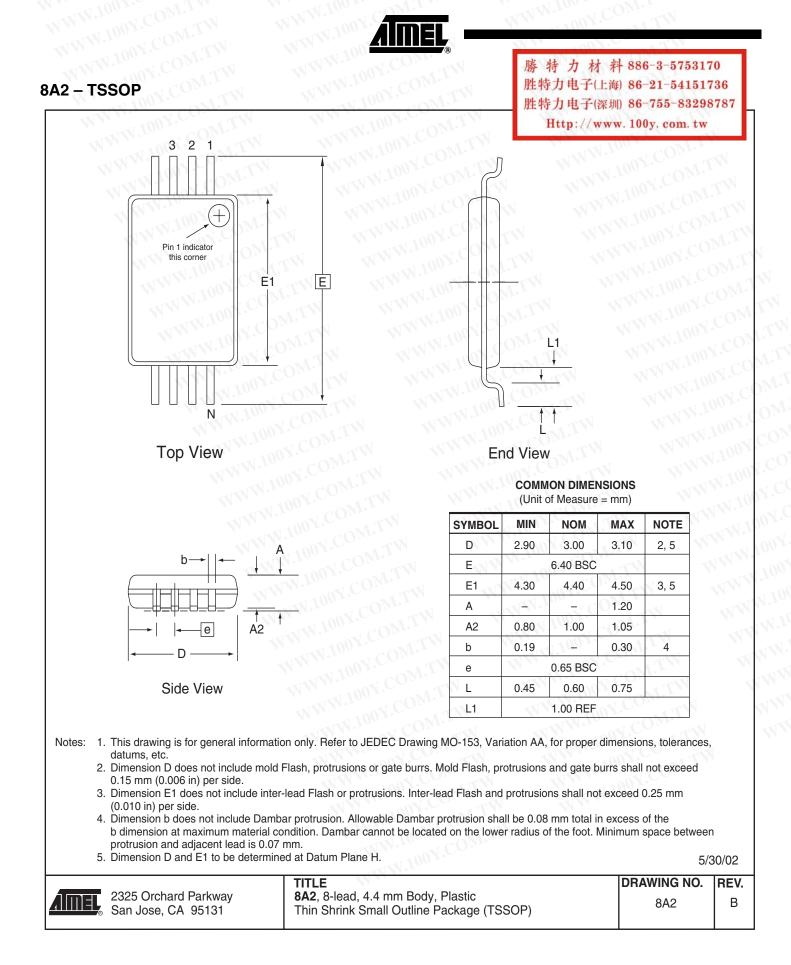
6. b2 and b3 maximum dimensions do not include Dambar protrusions. Dambar protrusions shall not exceed 0.010 (0.25 mm).

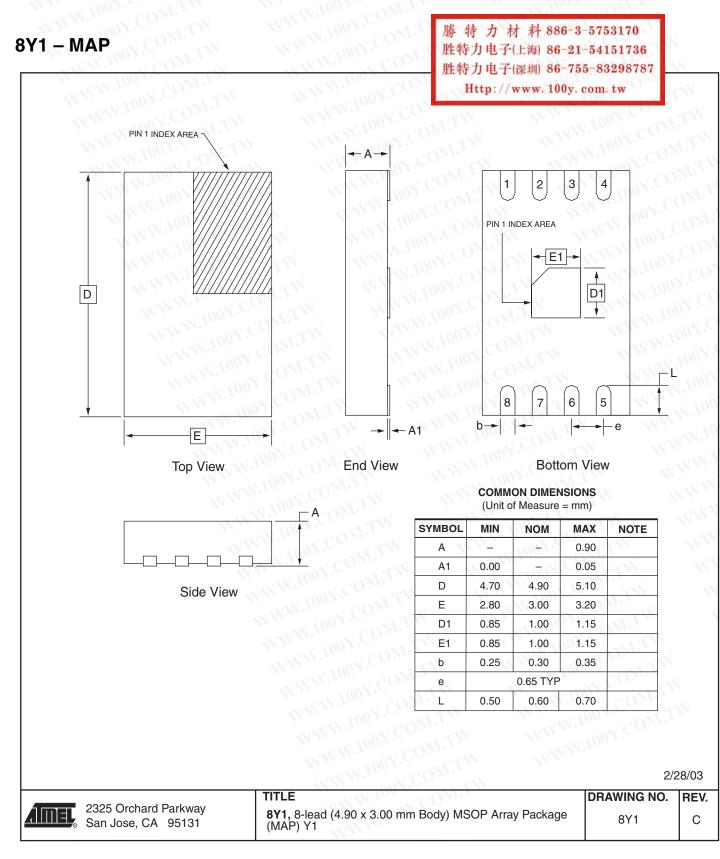
		01	/09/02
2325 Orchard Parkway San Jose, CA 95131	TITLE 8P3, 8-lead, 0.300" Wide Body, Plastic Dual In-line Package (PDIP)	DRAWING NO. 8P3	REV. B

## 8S1 - JEDEC SOIC

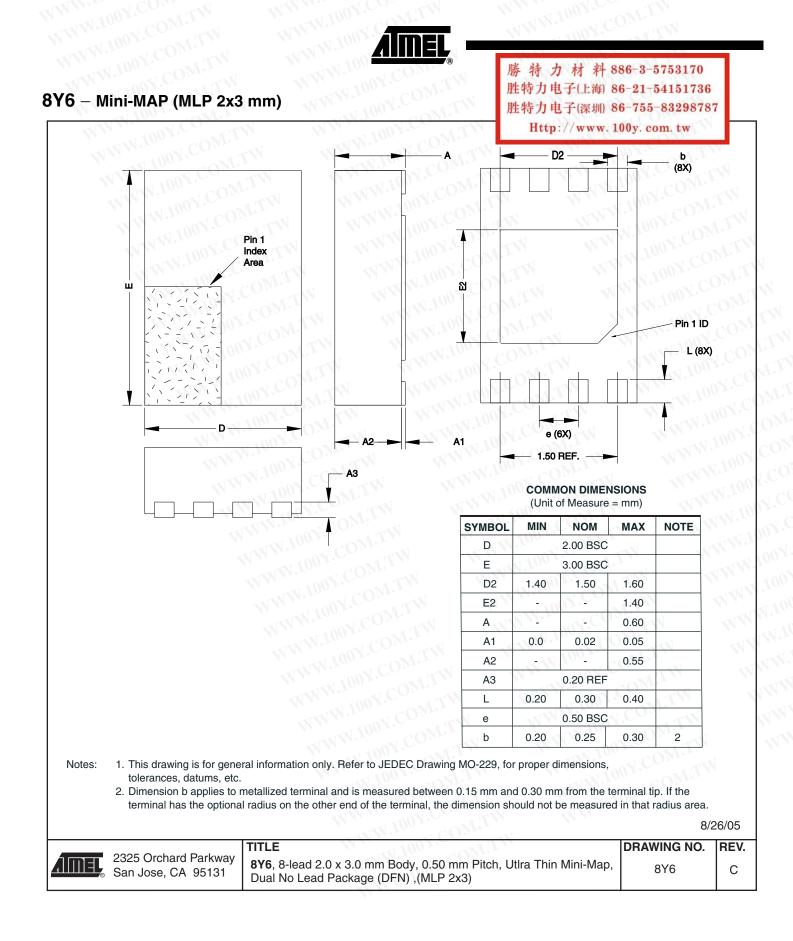




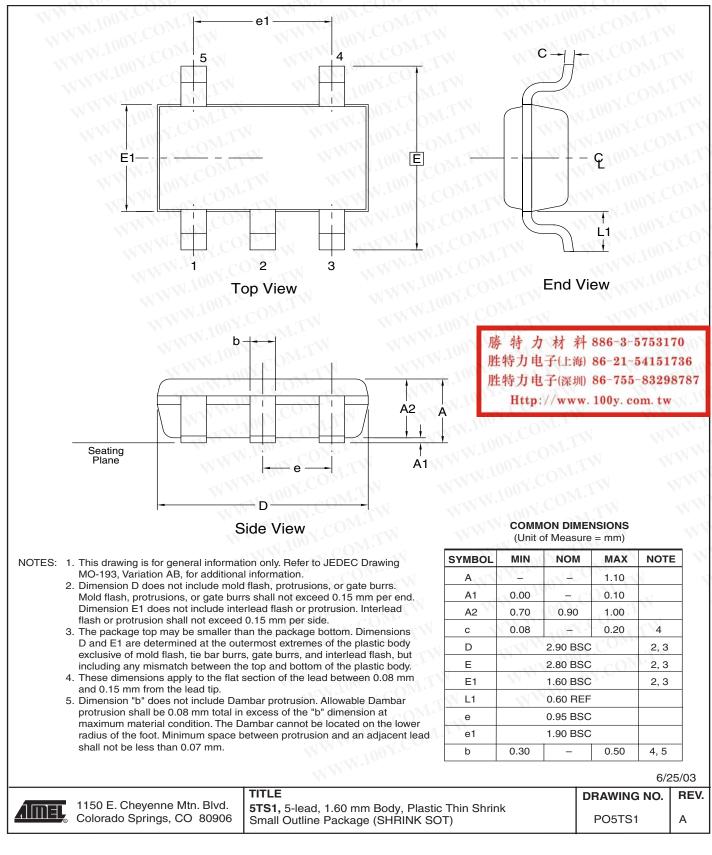








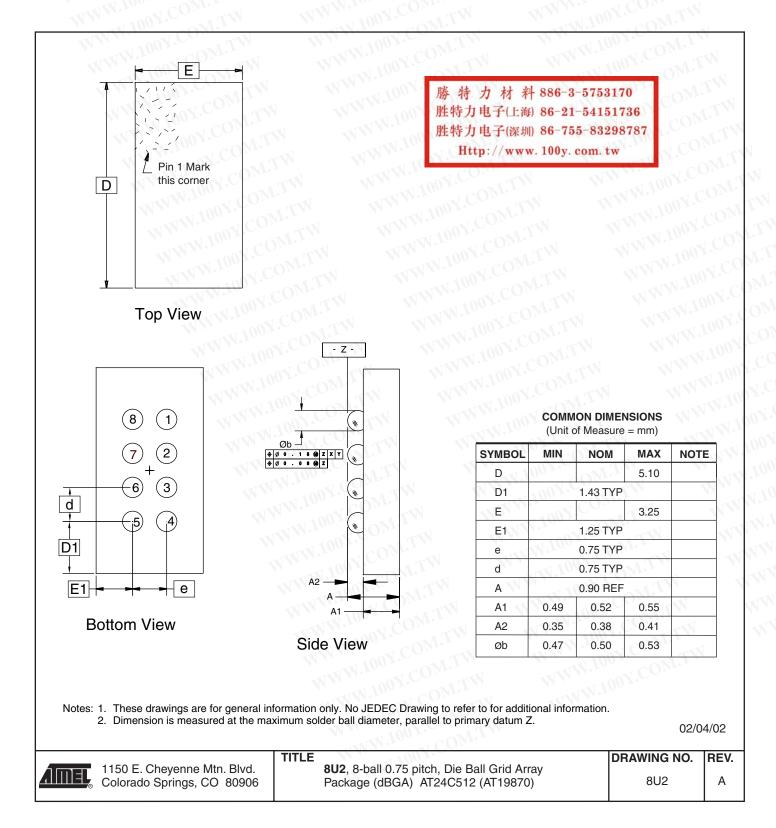
## 5TS1 - SOT23





AIMEL

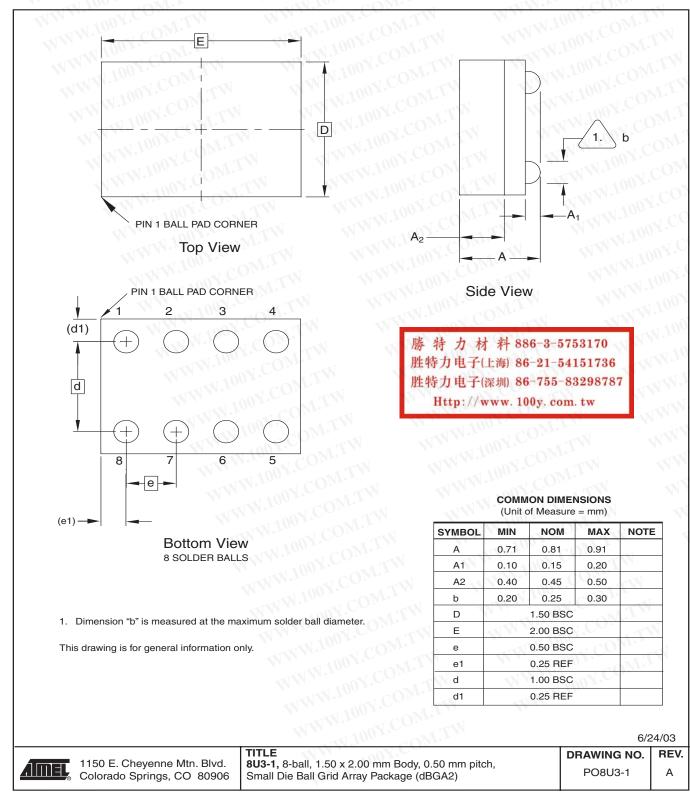
8U2 – dBGA2



# 24 AT24C01A/02/04/08A/16A

0180Y-SEEPR-2/06

## 8U3-1 - dBGA2







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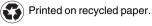
1150 East Cheyenne Mtn. Blvd. Colorado Springs, CO 80906, USA Tel: 1(719) 576-3300 Fax: 1(719) 540-1759

Biometrics/Imaging/Hi-Rel MPU/ High Speed Converters/RF Datacom Avenue de Rochepleine BP 123 38521 Saint-Egreve Cedex, France Tel: (33) 4-76-58-30-00 Fax: (33) 4-76-58-34-80

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0180Y-SEEPR-2/06